onsemi

Automotive 750 V, 800 A Dual Side Cooling Half-Bridge Power Module

VE-Trac[™] Dual Gen II NVG800A75L4DSB2

Product Description

The NVG800A75L4DSB2 is part of a family of power modules with dual side cooling and compact footprints for Hybrid (HEV) and Electric Vehicle (EV) traction inverter application.

The module consists of two narrow mesa Field Stop (FS4) IGBTs in a half-bridge configuration. The chipset utilizes the new narrow mesa IGBT technology in providing high current density and robust short circuit protection with higher blocking voltage to deliver outstanding performance in EV traction applications.

Liquid cooling heatsink reference design, loss models and CAD models are available to support customers in inverter designs.

Features

- Dual-Side Cooling
- Integrated Chip Level Temperature and Current Sensor
- $T_{vi max} = 175^{\circ}C$ for Continuous Operation
- Low-stray Inductance
- Low Conduction and Switching Losses
- Automotive Grade
- 4.2 kV Isolated DBC Substrate
- AEC Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

Typical Applications

- Hybrid and Electric Vehicle Traction Inverter
- High Power DC–DC Converter



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

PIN DESCRIPTION

Pin #	Pin	Pin Function Description	Pin Arrangement
1	N	Low Side Emitter	2
2	Р	High Side Collector	9
3	H/S COLLECTOR SENSE	High Side Collector Sense	3 0
4	H/S CURRENT SENSE	High Side Current Sense	
5	H/S EMITTER SENSE	High Side Emitter Sense	
6	H/S GATE	High Side Gate	and the second second
7	H/S TEMP SENSE (CATHODE)	High Side Temp sense Diode Cathode	
8	H/S TEMP SENSE (ANODE)	High Side Temp sense Diode Anode	
9	~	Phase Output	
10	L/S CURRENT SENSE	Low Side Current Sense	
11	L/S EMITTER SENSE	Low Side Emitter Sense	
12	L/S GATE	Low Side Gate	
13	L/S TEMP SENSE (CATHODE)	Low Side Temp sense Diode Cathode	
14	L/S TEMP SENSE (ANODE)	Low Side Temp sense Diode Anode	14 0
15	L/S COLLECTOR SENSE	Low Side Collector Sense	0

Materials

DBC Substrate: Al₂O₃ isolated substrate, basic isolation, and copper on both sides.

Lead Frame

Copper with Tin electro-plating.

Flammability Information

All materials present in the power module meet UL flammability rating class 94V-0.

MODULE CHARACTERISTICS

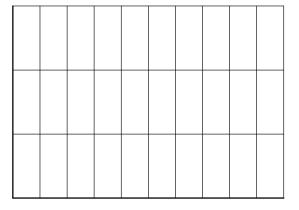
Symbol	Parameter			Rating	Unit
Τ _{νj}	Continuous Operating Junction Temperature Range			-40 to 175	°C
T _{STG}	Storage Temperature range			-40 to 125	°C
V _{ISO}	4200	V			
Creepage	5.0	mm			
Clearance	3.2	mm			
CTI	Comparative Tracking Index			>600	
		Min	Тур	Max	
L _{sCE}	Stray Inductance		8		nH
R _{CC'+EE'}	Module Lead Resistance, Terminals – Chip		0.15		mΩ
G	Module Weight		75		g
М	M4 Screws for Module Terminals		2.2	Nm	

1. Verified by design / not by test.

CHARACTERISTICS OF IGBT (Tvj = 25°C, Unless Otherwise Specified)

Parameters	Conditions	Min	Тур	Max	Unit
V _{CESAT}					

TYPICAL CHARACTERISTICS

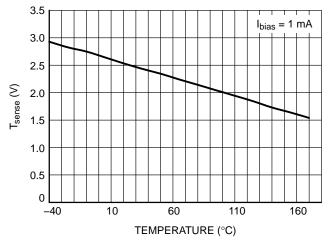


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TYPICAL CHARACTERISTICS





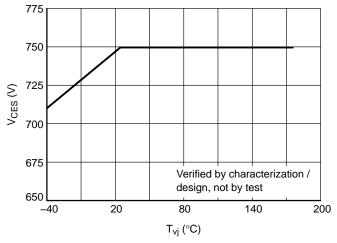


Figure 21. Maximum Allowed V_{CE}

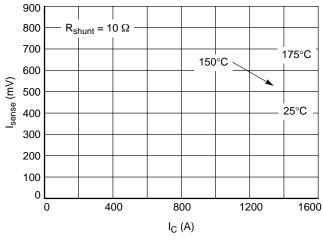
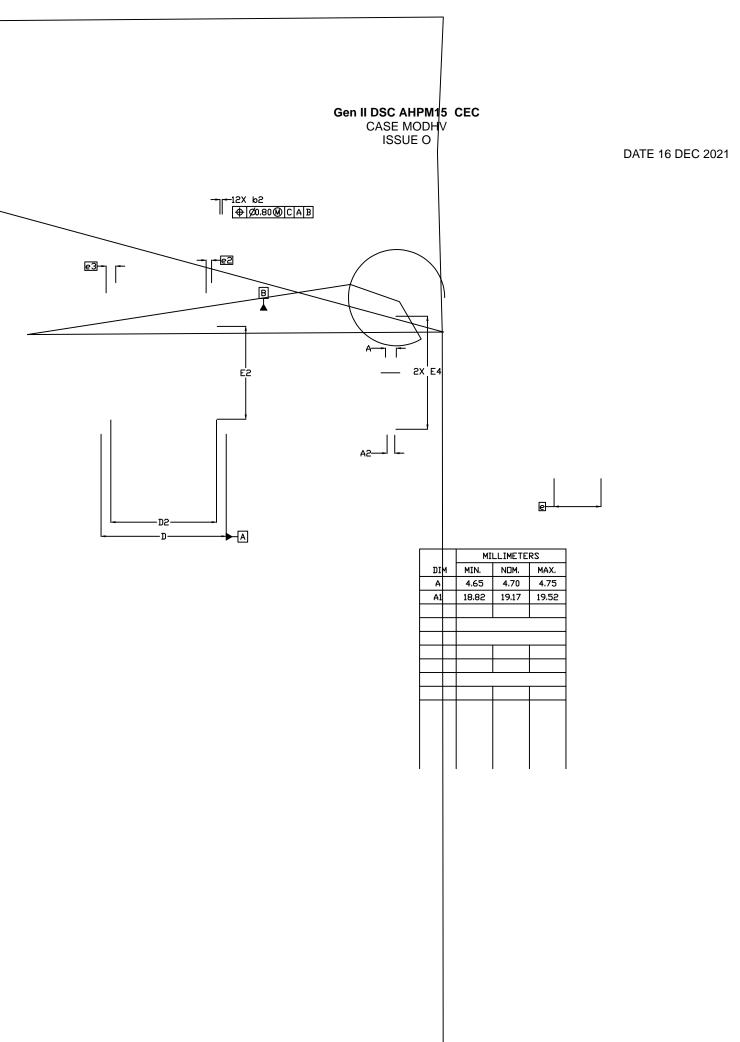
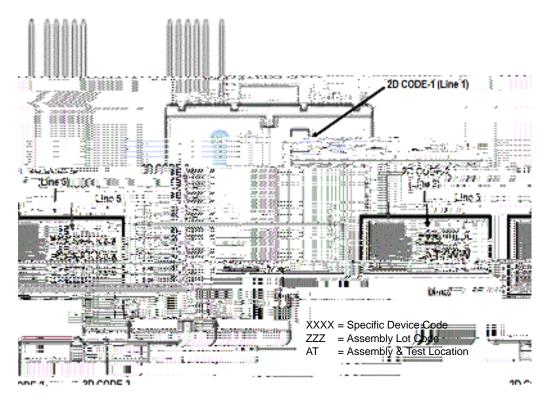


Figure 20. Current Sensor Characteristic



Gen II DSC AHPM15 CEC CASE MODHV ISSUE O

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